

On the formation of antiphase boundaries in Fe₄Al₁₃ intermetallics during a high temperature treatment

Lipeng Ding^{a,b,c,*}, Thaneshan Sapanathan^{b,d}, Dominique Schryvers^c, Aude Simar^b, Hosni Idrissi^{b,c}

^a Key Laboratory for Light-Weight Materials, Nanjing Tech University, Nanjing 211816, China

^b UCLouvain, Institute of Mechanics Materials and Civil Engineering, IMAP, Louvain-la-Neuve, 1348, Belgium

^c Electron Microscopy for Materials Science (EMAT), Department of Physics, University of Antwerp, Antwerp 2020, Belgium

^d Curtin Corrosion Centre, Faculty of Science and Engineering, Curtin University, Perth, WA 6102, Australia

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ABSTRACT

In this paper, we report atomic scale observations and formation mechanisms of a high-density of antiphase boundaries (APBs) within an ultra-fine-grained Fe₄Al₁₃ intermetallic layer at an Al/steel interface after a heat treatment at 596 °C. The results reveal that the APBs are formed by nucleation and the glide of partial dislocations with Burgers vector of $b/3[010]$ ($b = 12.47 \text{ \AA}$). The intensive activation of APBs locally transforms the Fe₄Al₁₃ structure from the quasicrystal approximant structure to a quasicrystal. Very few stacking faults and nanotwins are observed indicating that the formation of planar defects is mainly driven by this transformation. This new insight on the formation of high density of APBs could possibly lead to an improvement in toughness by increasing the strength/ductility balance of this intermetallic.

Iron aluminides are largely investigated systems as they spontaneously form during many modern engineering applications such as dissimilar welding, coating, hot dip aluminizing and fabrication of *in situ* composites [1]. Stable iron aluminide intermetallics with more than 50 at.% of aluminum (FeAl₂ – ζ, Fe₂Al₅ – η and Fe₄Al₁₃ – θ also referred to as FeAl₃ in some early literature) exhibit very low toughness. FeAl₂ – ζ, Fe₂Al₅ – η and Fe₄Al₁₃ – θ phases have a room temperature toughness of 0.59 MPa•m^{1/2}, 0.82 MPa•m^{1/2} and 0.97 MPa•m^{1/2}, respectively [2]. This is attributed to the presence of strong covalent bonding, which makes dislocation motion difficult. To improve the ductility of the IMs, several strategies have been applied such as severe plastic deformation, introduction of nanotwins or bimodal microstructure [3]. However, most of these methods are a trade-off between strength and plasticity. It has also been demonstrated that planar defects generated during processing could play an important role to improve ductility by acting as sources for dislocations [4–6]. Therefore, understanding the elementary defect mechanisms is important to improve the strength-ductility balance in this class of materials.

Chen et al. [7] reported the formation of high-density of nanoscale planar defects including stacking faults and twins within the Fe₄Al₁₃ phase in the molten aluminum/solid steel IM layer. Fung et al. [8]

observed the presence of Fe₄Al₁₃ tenfold twins and Al-Fe decagonal quasicrystal in a rapidly solidified Al-Fe alloy while Saito et al. [9] reported the existence of three kinds of twins, i.e. (001), (100) and (20–1) twin in the Fe₄Al₁₃ phase. In Co₄Al₁₃ phase, which is homeotypic with Fe₄Al₁₃, the formation of a high density of dislocations with [010] Burgers vector terminating (001) planar defects was observed during deformation [10]. Korte-Kerzel et al. [3] demonstrated that the plasticity at room temperature in the Co₄Al₁₃ phase is controlled by the motion of metadislocations, which are highly complex partial dislocations mediating plasticity in various IMs. Anti-phase boundaries (APBs) are frequently observed in IMs with superlattice, such as Ni (Co)-based single crystal super alloy [11,12]. However, to the best of the author's knowledge, such defects have rarely been directly observed for the Fe₄Al₁₃ phase. In the present work, a high density of APBs formed within the Fe₄Al₁₃ intermetallic is reported. Aberration corrected high resolution scanning transmission electron microscopy (HRSTEM) is used to investigate the atomic scale characteristics of these defects as well as their formation mechanisms.

Friction Melt Bonding (FMB) process is used to obtain an Al/Fe interface with two intermetallics (Fe₂Al₅ and Fe₄Al₁₃). FMB is a recently developed process to weld dissimilar materials. More information on the

* Corresponding author at: Key Laboratory for Light-Weight Materials, Nanjing Tech University, Nanjing 211816, China.

E-mail address: lipeng.ding@njtech.edu.cn (L. Ding).

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FMB process can be found elsewhere [13,14]. First, a dual phase (DP600) steel plate is placed on top of the aluminum. During FMB, the heat generated by the friction between the tool and the steel plate is sufficient to melt the aluminum. This facilitates reaction and diffusion between the liquid aluminum and solid steel leading to the formation of Fe_2Al_5 and $\text{Fe}_4\text{Al}_{13}$ intermetallics at the interface [13,15]. Scanning electron microscopy (SEM) observations were made on the transverse section of the FMB welded interface with secondary electrons using a ZEISS FEGSEM (Field emission gun scanning electron microscopy) Ultra 55 instrument. 300 μm thick specimens extracted from the interface zone containing both Fe_2Al_5 and $\text{Fe}_4\text{Al}_{13}$ IMs, aluminum and steel, have been heat treated at 596 $^\circ\text{C}$ for 6 min. The temperature-time plot used during the heat treatment is given in Supplementary Fig. S1. This enabled the growth of the IMs. Cross-sectional TEM thin foils were also prepared using a dual-beam Scanning Electron Microscope/Focused Ion Beam (SEM/FIB) instrument (FEI Helios Nanolab 650) with the “lift-out” procedure. Bright-field TEM (BF-TEM) images and selected area electron

diffraction (SAED) were acquired in a FEI Tecnai G2 F20 TEM operated at 200 kV. A FEI Titan 80–300 “Cube” microscope with double aberration correctors (image and probe correction) was used to investigate the local atomic structure of the IM.

The SEM observation in Fig. 1a shows that the IM layer formed after FMB at the Al/Steel interface exhibits an average thickness of $7.1 \pm 1.5 \mu\text{m}$. It can also be seen that this layer involves two different iron aluminides as separated by a white dotted line (Fig. 1a). Earlier investigations confirmed that Fe_2Al_5 is formed on the steel side while $\text{Fe}_4\text{Al}_{13}$ is formed on the aluminum side [16]. Cross-sectional FIB lamellae are thus lifted out from the steel and aluminum side IM to investigate the Fe_2Al_5 and $\text{Fe}_4\text{Al}_{13}$ phases respectively. Significant microstructural changes were not detected in the existing Fe_2Al_5 phase after 596 $^\circ\text{C}$ heat treatment while the $\text{Fe}_4\text{Al}_{13}$ phase yields some interesting microstructural changes as will be detailed later. TEM-BF images of the IMs before and after the heat treatment are presented in Fig. 1b and c, respectively. In Fig. 1b, the $\text{Fe}_4\text{Al}_{13}$ IM exhibits grain sizes ranging

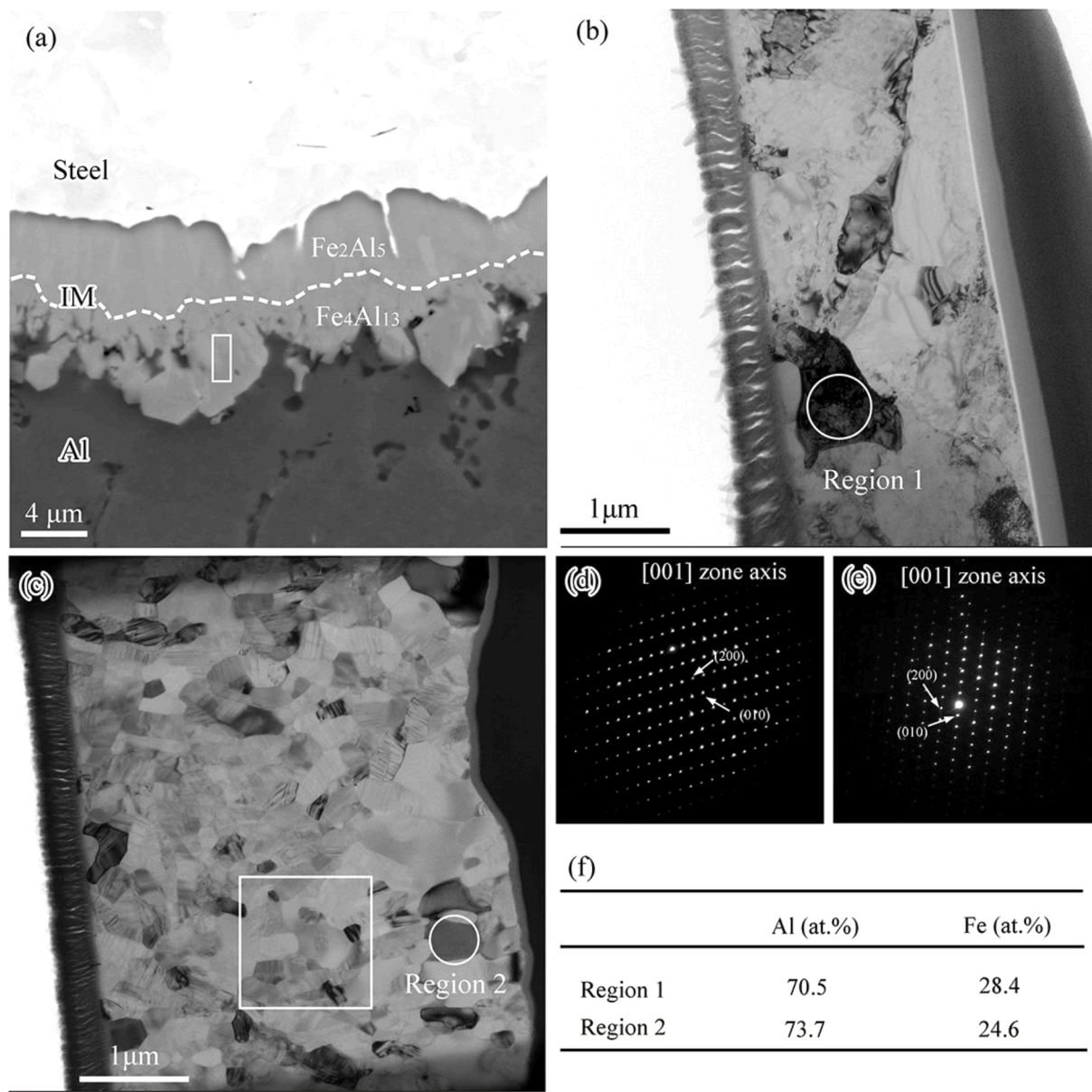


Fig. 1. (a) Backscattered SEM micrograph of the IMs formed at the Al/Steel interface after FMB. (b, c) TEM bright-field micrographs of the $\text{Fe}_4\text{Al}_{13}$ phase formed at the interface before and after the 596 $^\circ\text{C}$ heat treatment, respectively. The SAED patterns in (d) and (e) are obtained in the regions marked by the white circles in (b) and (c), respectively. (f) EDX results corresponding to the regions marked by white circles in (b) and (c). The white rectangle corresponds to the zone selected for detailed analysis in Fig. 2.

from 1 to 2 μm with only few dislocations within the grains. After the 596 °C heat treatment, the grains became more equiaxed with grain size between 100 nm and 500 nm (Fig. 1c). The SAED patterns obtained in the regions marked by white circles in Fig. 1b and c and shown in Fig. 1d and e, respectively, confirm the presence of the $m\text{-Fe}_4\text{Al}_{13}$ phase with a monoclinic structure before and after the 596 °C heat treatment. This was consolidated using SAED patterns acquired along other zone axes (see supplementary Fig. S2). TEM-EDX (Energy dispersive X-ray spectroscopy) measurements performed in the same regions support the identification of the $\text{Fe}_4\text{Al}_{13}$ phase (Fig. 1f).

Fig. 2a shows a magnified TEM-BF image of the area marked by the white rectangle in Fig. 1c. In this figure, most of the grains contain nanoscale parallel planar defects (see black arrows in Fig. 2a). The TEM-BF image of Fig. 2b shows that some planar defects are rather straight (red arrow) while others exhibit a more curved aspect (blue arrow). In the SAED pattern shown in the inset of Fig. 2b, diffraction spots with strong streaks are observed along the (010) plane, indicating the presence of edge-on planar defects parallel to this plane. Fig. 2c exhibits an HAADF-STEM image of the $m\text{-Fe}_4\text{Al}_{13}$ phase without planar defects viewed along [001] zone axis. The monoclinic unit cell is marked by red lines in this figure. The $m\text{-Fe}_4\text{Al}_{13}$ structure can be described by the tiling of two rhombs and a pentagon connected with a second pentagon rotated by 180°. This arrangement leads to a flat octagon-type substructure. Therefore, the $\text{Fe}_4\text{Al}_{13}$ phase is considered as a decagonal quasicrystal approximant. The periodic arrangement of the octagon-type substructure can be schematized as shown in Fig. 2d.

Fig. 3a and d exhibit high resolution high angle annular dark-field scanning transmission electron microscopy (HAADF-STEM) images of the straight and curved planar defects shown in Fig. 2b, respectively. In these figures, the planar defects are marked by yellow lines while the unit cell of the $m\text{-Fe}_4\text{Al}_{13}$ is indicated by red lines. Fig. 3b shows a magnified HAADF-STEM image of the region indicated by the blue

square in Fig. 3a. The rhombs at the planar defect (orange filled zones) are rotated by $\sim 223.45^\circ$ with respect to the rhombs in the matrix (blue filled zones). Detailed analysis of the arrangement of these rhombs confirms the presence of the $o\text{-Fe}_4\text{Al}_{13}$ with orthorhombic structure at the planar defect. Therefore, the $m\text{-Fe}_4\text{Al}_{13}$ can transform to $o\text{-Fe}_4\text{Al}_{13}$ and then transform back to $m\text{-Fe}_4\text{Al}_{13}$ in this defect. In the schematic illustration of Fig. 3c, it can be seen that the planar defect is an anti-phase boundary (APB) formed by the translation of the $m\text{-Fe}_4\text{Al}_{13}$ unit cell by $b/3$ [010] in the (100) plane leading to local transformation from $m\text{-Fe}_4\text{Al}_{13}$ to $o\text{-Fe}_4\text{Al}_{13}$ as reported in [9]. Besides, the formation of these APBs leads to the loss of the periodic arrangement of the $m\text{-Fe}_4\text{Al}_{13}$ crystal leading to local transformation of the quasicrystal approximant into a quasicrystal. This is evidenced by the formation of a 5-fold symmetry pattern marked by the red circles in the FFT pattern inserted in the right corner of Fig. 3a [17], see also Fig. S3 in supplementary materials. In Fig. 3d, the APB exhibits a ‘zig-zag’ morphology with planes switching from (100) to $(1\bar{1}0)$. Fig. 3e exhibits a magnified HAADF-STEM image of the APB segment indicated by the green square in Fig. 3d. In Fig. 3e, a flat hexagon (light green filled zones) is formed when the APB switches from the (100) plane to the $(1\bar{1}0)$ plane. The schematic illustration of Fig. 3f shows the occurrence in this site of a translation of the $m\text{-Fe}_4\text{Al}_{13}$ crystal by $a/2$ [100] in the (010) plane and $b/3$ [010] in the (100) plane. Furthermore, no dislocation is detected at the same site (see Supplementary Fig. S4).

The HAADF-STEM images of Fig. 4 show planar defects with larger thickness (green lines). Some APBs can also be observed in these images (yellow lines). In Fig. 4a, the planar defect indicated by green lines has a thickness of 7.5 nm, which is half the unit cell size of $m\text{-Fe}_4\text{Al}_{13}$. Fig. 4b shows an enlarged HAADF-STEM image from the blue square in Fig. 4a. It clearly shows that a row of pentagon/rhomb tiles (the rhombs are orange filled) are rotated by 107° with respect to the matrix. Therefore, this planar defect can be considered as a stacking fault (SF) [3]. Note

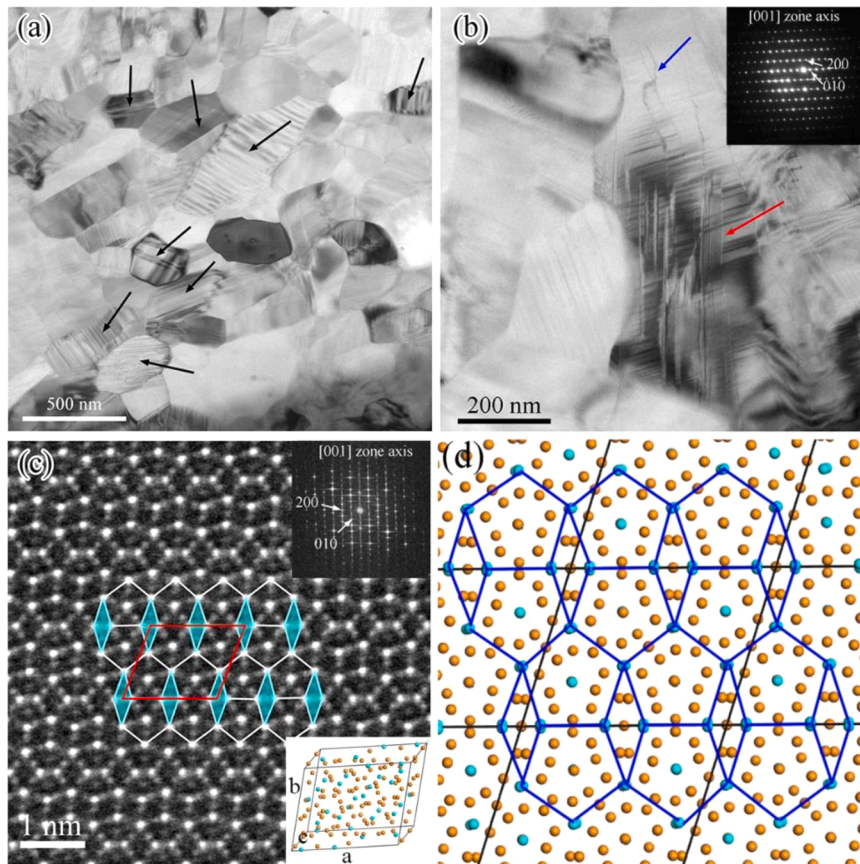


Fig. 2. (a and b) TEM bright-field images showing planar defects (black arrows in (a)) formed in the $\text{Fe}_4\text{Al}_{13}$ intermetallic phase after the 596 °C heat treatment. Straight and curved planar defects are marked by red and blue arrows, respectively. (c) HAADF-STEM image of the $m\text{-Fe}_4\text{Al}_{13}$ phase without planar defects observed along [001] zone axis. The rhombs are light blue filled and the unit cell is marked by red lines. (d) Schematic illustration of the substructure of the $\text{Fe}_4\text{Al}_{13}$ phase. The unit cell of $\text{Fe}_4\text{Al}_{13}$ is marked by black lines while tiling octagons are highlighted by blue lines. The Fe and Al atoms are marked by blue and orange spheres, respectively.

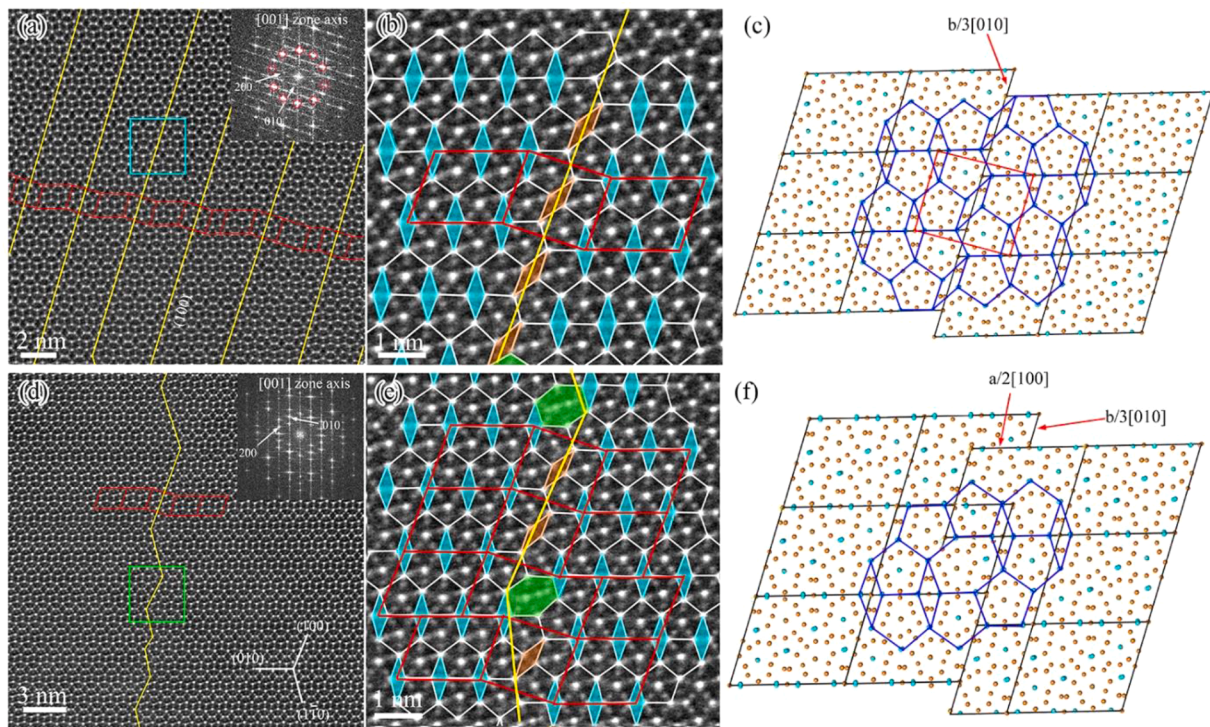


Fig. 3. (a and d) High resolution HAADF-STEM images of APBs in the m-Fe₄Al₁₃ phase. The unit cells of the m-Fe₄Al₁₃ are marked by red lines while the APBs are indicated by yellow lines. (b and e) Magnified HAADF-STEM images from the blue and green squares in (a and d), respectively. Tiling octagons are marked by white lines. The rhombs are filled by light blue and orange depending on their orientations. The 5-fold symmetry patterns are marked by the red circles in the FFT pattern. The flat hexagons in (e) are filled by light green. (c and f) Schematics illustrating explaining the formation of the APB within the m-Fe₄Al₁₃ phase shown in (b) and (e).

here the difference between SF and APB. Indeed, the formation of a SF is associated with a row pentagon/rhomb tile (half unit cell of the m-Fe₄Al₁₃) twinned with respect to the matrix [3], while APB causes local shift of the m-Fe₄Al₁₃ unit cell by $b/3[010]$ in the (100) plane [8]. The nanoscale lamella delimited by the green lines in Fig. 4c is clearly identified as (100) twin stopping inside the grain [9]. The presence of streaking in the FFTs agrees with the observation of stacking faults and nanosized twins. In Fig. 4d, the magnified HAADF-STEM image from the blue square in Fig. 4c confirms that the formation of the (100) twin involves the formation four twin-like rows of pentagon/rhomb tiles (the rhombs are orange filled) rotated by 107°. A series of irregular polygons (marked by white lines) is formed at the tip of the twin (Fig. 4d). The local g-map inset in Fig. 4c was obtained using Geometric Phase Analysis (GPA) which is an image processing method sensitive to small displacements of the lattice fringes in high resolution TEM images. It reveals the presence of a dislocation at the tip of the twin, indicating the incoherent character of the twin front. The core of this dislocation is identified by a Burgers circuit using unstrained tiles (Fig. 4e). The Burgers vector is identified as $b = b/\tau^5(010)$, with $|b| = 0.113$ nm, where $\tau = 1/2(\sqrt{5} + 1)$. These observations show that different types of extended defects including APBs, stacking faults and twins have been formed in the Fe₄Al₁₃ intermetallic after the 596 °C heat treatment. It is worth noting that the formation of APBs in a ZrAl₃ nano-precipitate are the consequence of successive shears with $a/2\langle 110 \rangle$ dislocations gliding on distinct (111) planes [21]. In the present work, recrystallization might occur during the 596 °C heat treatment of the Al/steel

joint which could explain to the formation of ultrafine grains and extended defects such as APBs, stacking faults and nanotwins [22]. The origin of APBs can be attributed to the increase of the local stress during the 596 °C heat treatment or friction melt bonding as the intermetallic compounds have a different thermal expansion compared to steel and aluminum [23]. Furthermore, In the presence of such small grain size, grain boundaries could act as preferential sites for the nucleation of APBs.

It has also been reported that the APBs could lead to stress homogenization through dislocation/APB interactions, resulting in a reduction of the tendency for intergranular failure in ordered IMs [24]. Due to the presence of APBs along with other microstructural defects, the desired high temperature mechanical properties could be achieved in FeAl and Fe₃Al [25]. Although Fe₄Al₁₃ alone has limited direct applications, it has been widely utilized in metal matrix composite along with aluminum alloys [26]. Thus, developing more insight on the elastic and plasticity mechanisms in Fe₄Al₁₃ is beneficial for many industrial applications. In the present work, the high density of APBs in the Fe₄Al₁₃ IM is resulting from the presence of dislocations with large magnitude of Burgers vector ($b/3[010]$, $b = 12.47$ Å), leading to high stacking fault energy and making the formation of stacking faults and twins less energetically favorable. The combined effect of small grain size and the very high density of APBs could lead to outstanding strength/ductility balance. Further experimental efforts are needed to investigate the role of the APBs observed in the present work on the micromechanical response of the Fe₄Al₁₃ IM. Special attention will have to be paid to the elementary dislocation/APB interaction mechanisms using *in-situ* TEM nano-mechanical testing [27].

In summary, high density of APBs are formed in the Fe₄Al₁₃ intermetallic of the Al-Fe welds after a heat treatment at 596 °C. The formation of a high density of APBs transforms the Fe₄Al₁₃ structure from the quasicrystal approximant to quasicrystal. Since Fe₄Al₁₃ intermetallic is detrimental for the Al/steel weld performance due to its very low

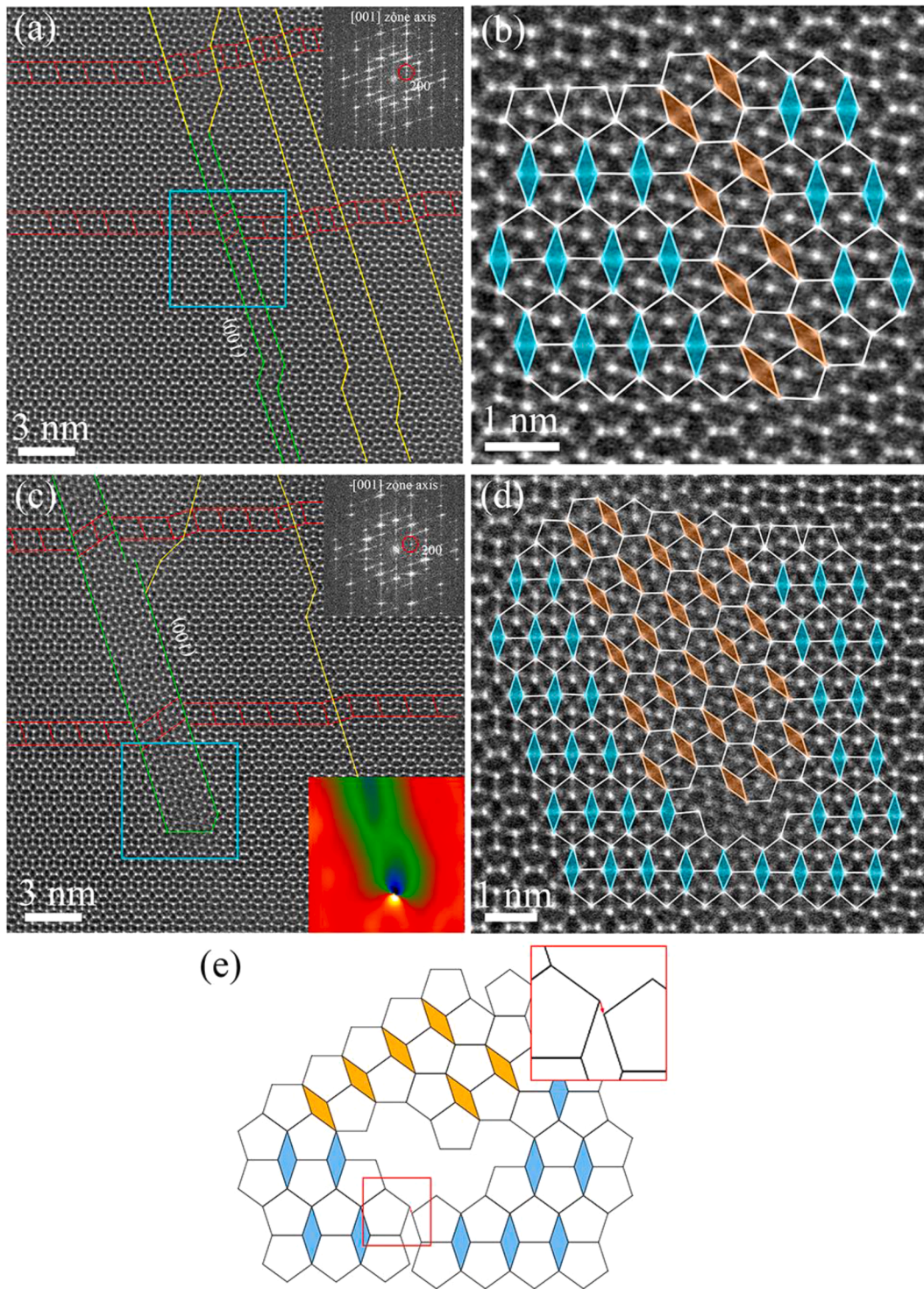


Fig. 4. (a and c) HAADF-STEM images of two planar defects with larger thickness (marked by green lines). (b and d) are enlarged HAADF-STEM images corresponding to the blue squares in (a) and (c), respectively. Stacking faults and twins are marked by green lines in (a) and (c) while APBs are indicated by yellow lines. The change of pentagon/rhomb tiling at stacking fault and twins are superimposed and highlighted in orange. Local g map of the region marked by blue square in (c) is inserted in the bottom right of (c). It was obtained using the reflecting (200) plane marked by a red circle in the FFT of (c). (e) A Burgers circuit using unstrained tiles.

toughness, this new insight on the formation of large number of APBs merits to be further investigations as it has great potential to improve the toughness by increasing the strength/ductility balance.

Declaration of Competing Interest

The authors declare that they have no known competing financial interests or personal relationships that could have appeared to influence the work reported in this paper.

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Supplementary materials

Supplementary material associated with this article can be found, in the online version, at [doi:10.1016/j.scriptamat.2022.114726](https://doi.org/10.1016/j.scriptamat.2022.114726).

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